

Characterisation of an integrated SMD multisensor for compressed air in LTCC technology

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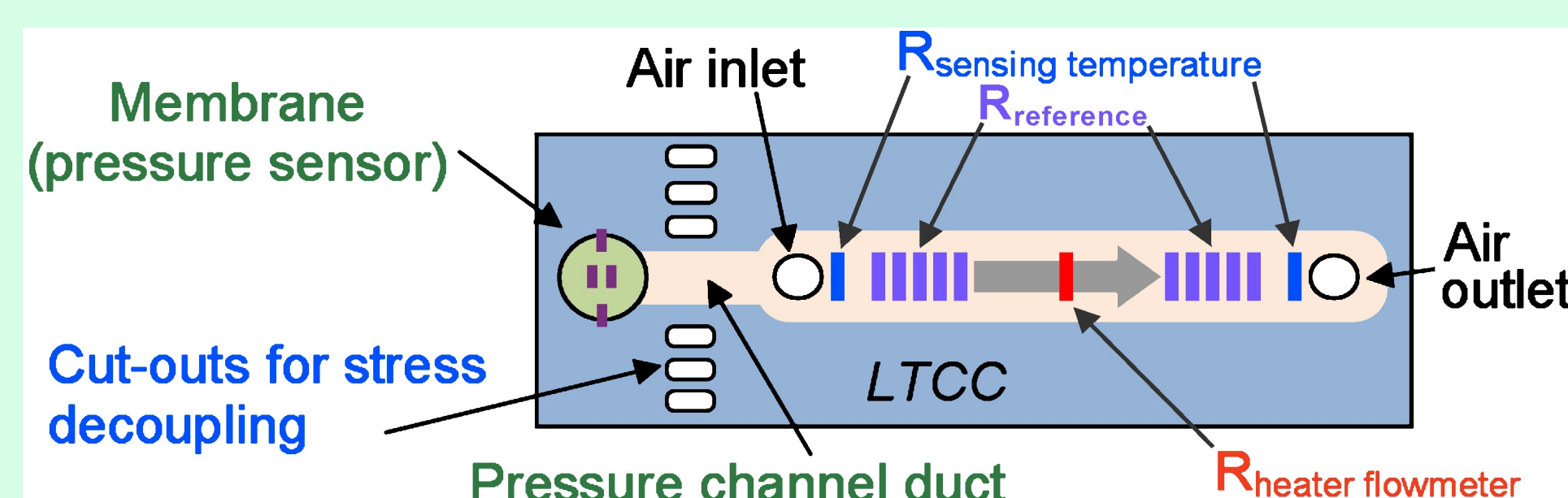
Industrial compressed air multisensor

Applications

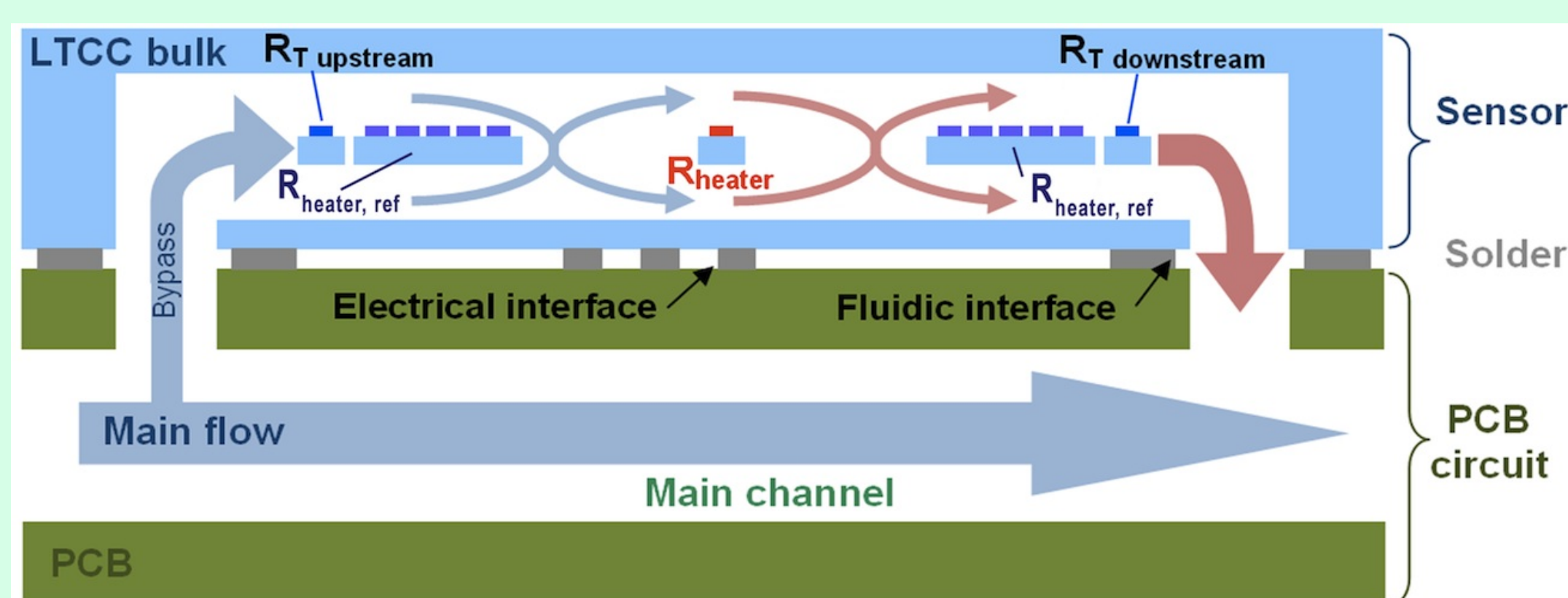
- Process control
- Monitoring of valves, circuits, etc. → **better reliability**

Features

- Robust measurement of pressure, flow & temperature
- Solderable as an SMD component onto fluidic boards
- Bypassable for large flows



Concept for compressed air flow-pressure-temperature multisensor



Cross section: soldering & bypassing for large flows

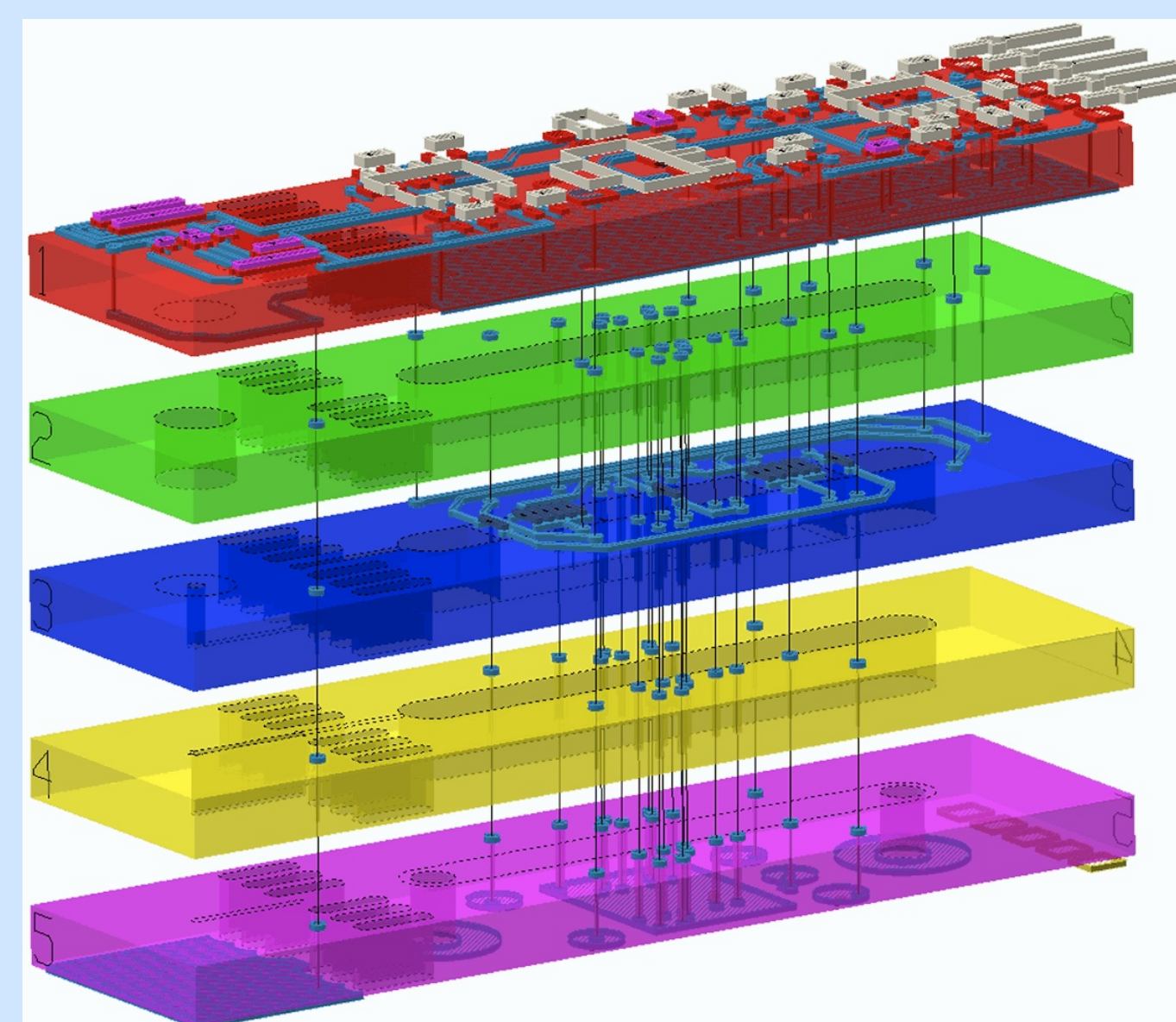
Fabrication : LTCC technology

Advantages

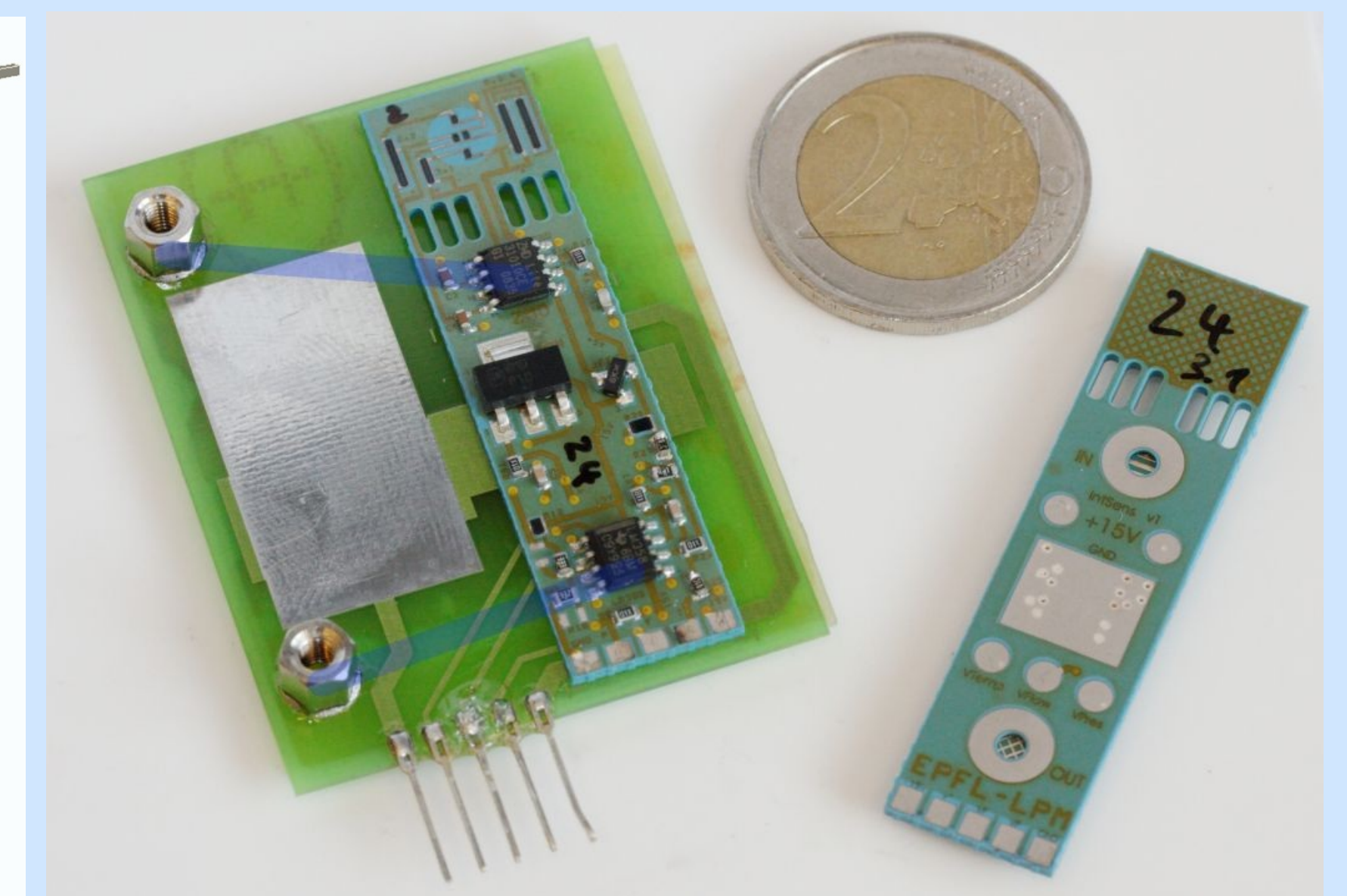
- Thermal, mechanical & chemical stability
- High 3D structuration capability
- Possible to integrate many active sensing materials

Sensing

- Flow : hot-wire anemometer → **PTC thermistors**
- Temperature → extra PTC thermistors
- Pressure → **piezoresistor** bridge on membrane
- + Adapted electronics



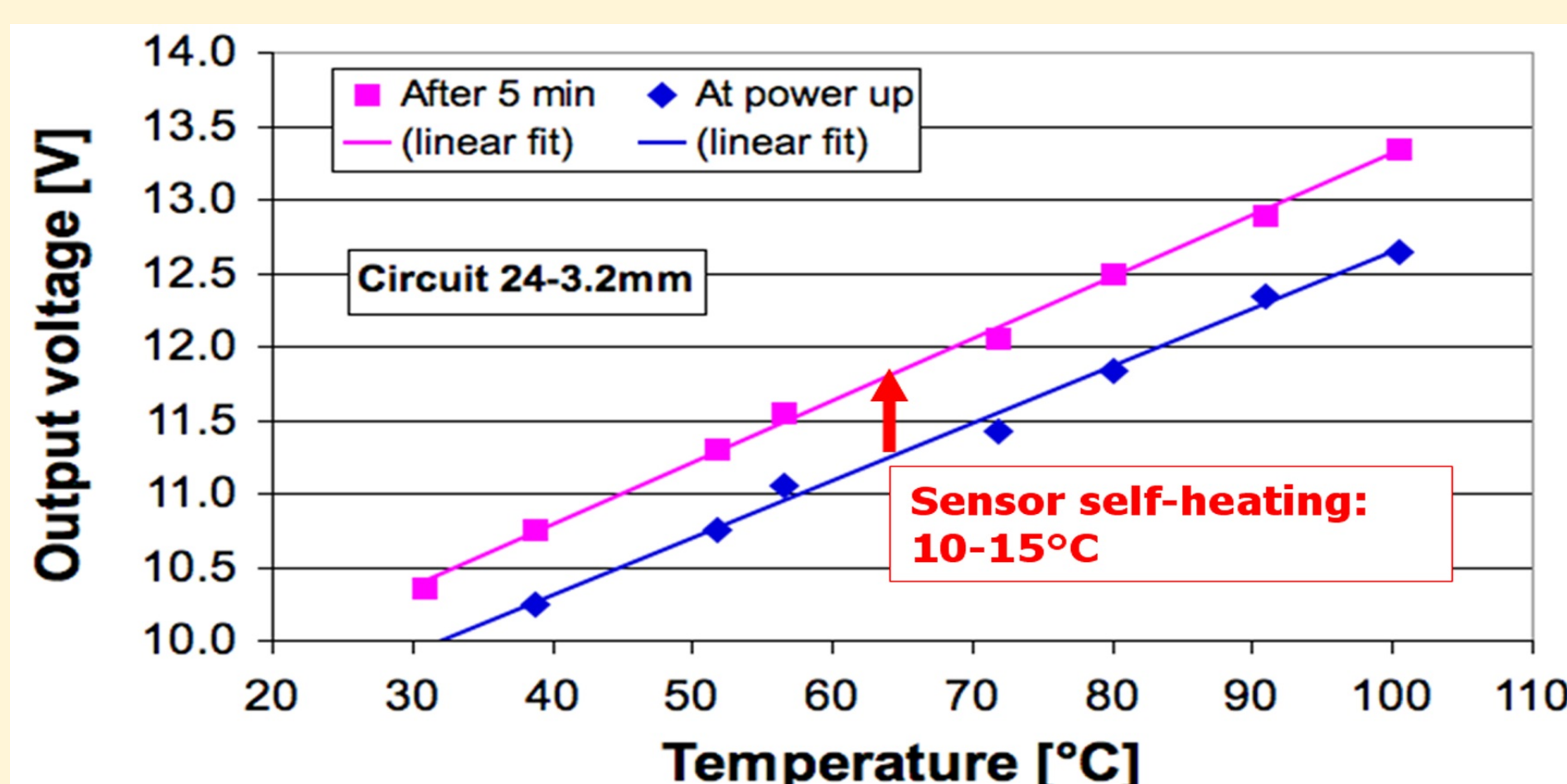
3D view of the 5 used LTCC layers



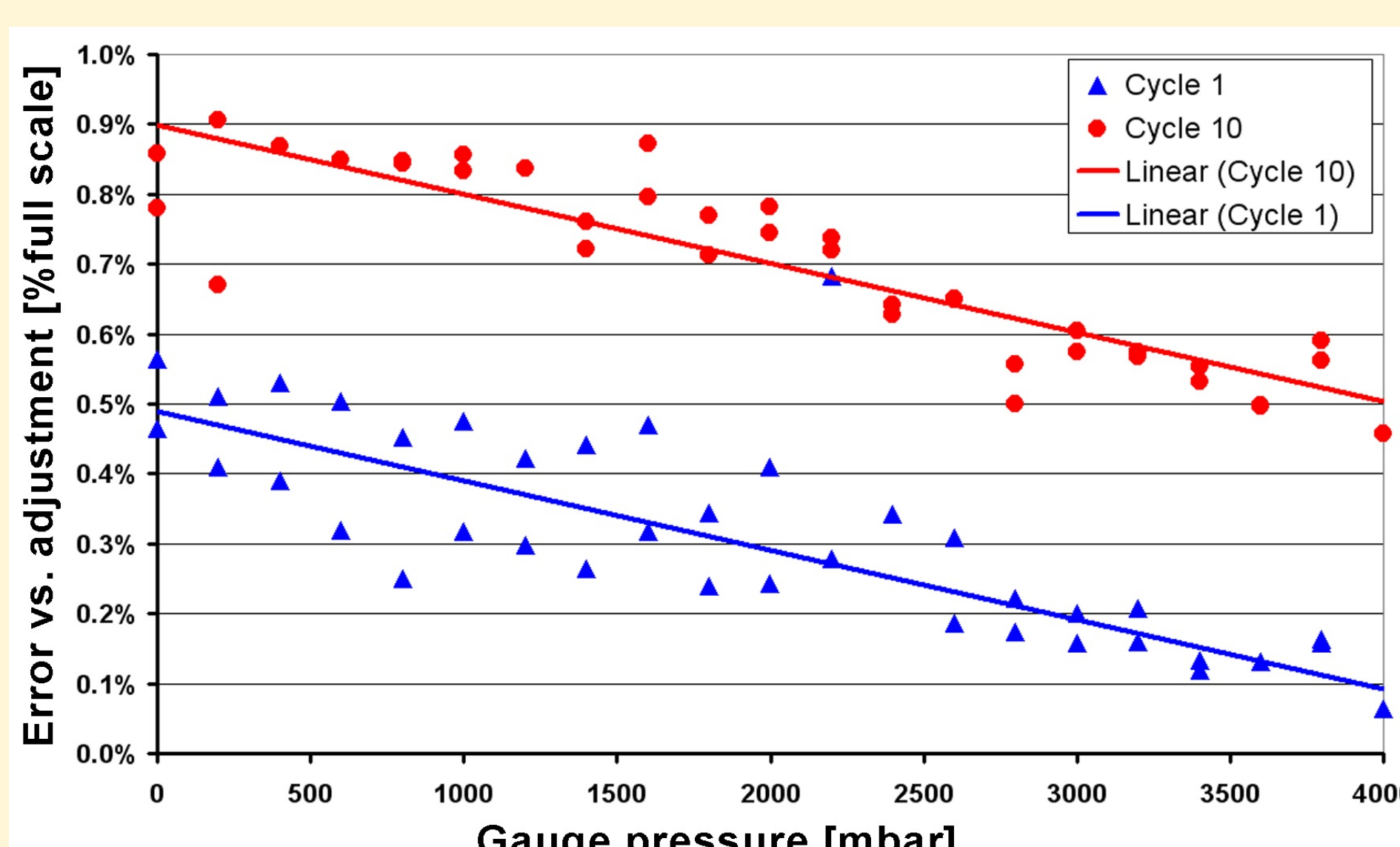
Resulting LTCC multisensor & test board

Results

- Very precise pressure output for typical compressed air conditions (≈ 8 bar)
- Nonlinear flow output suitable for sensing wide ranges
- Temperature signal for diagnostics purposes

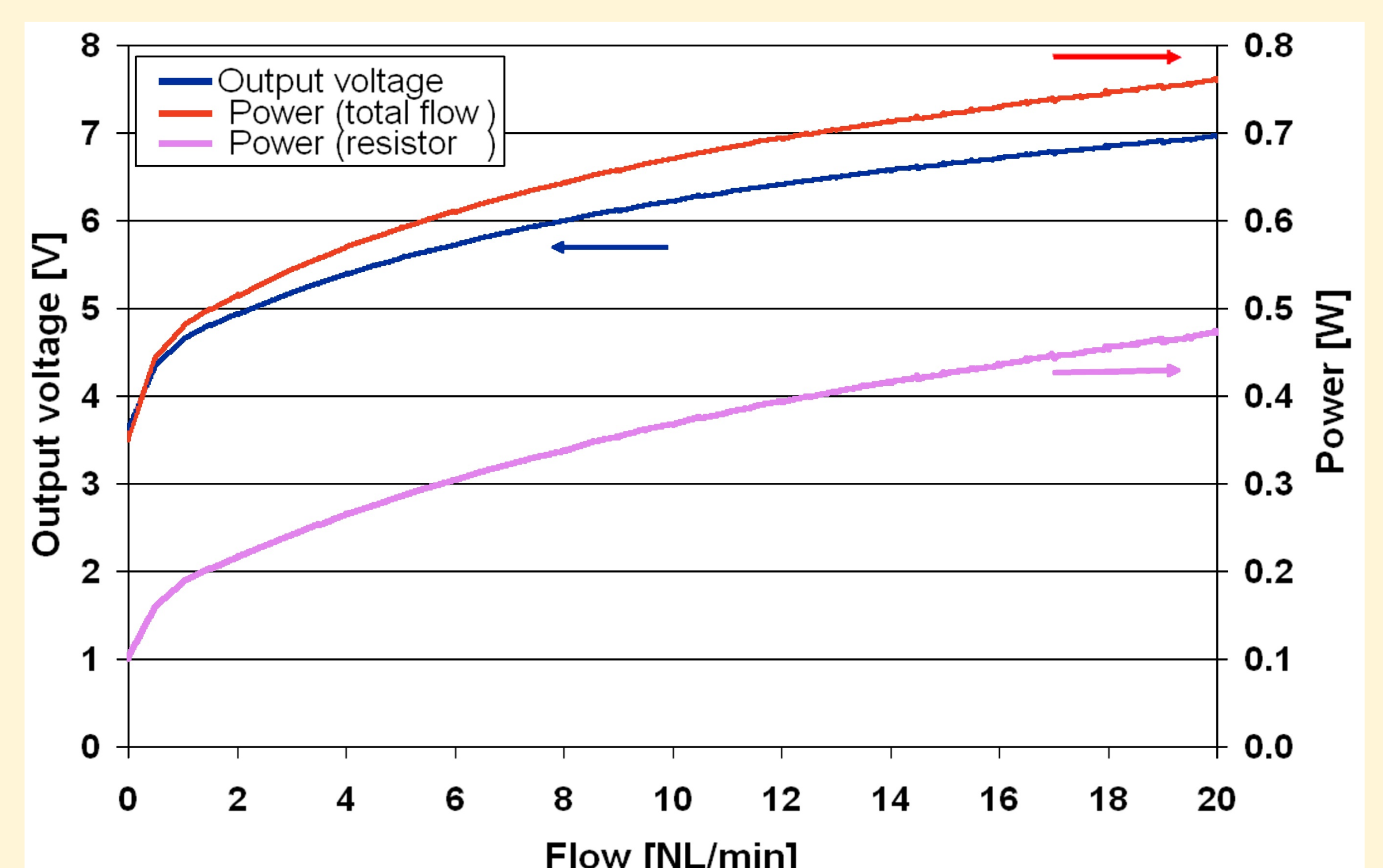


Temperature output



Pressure output

Flow sensor output signal



Conclusions

- Robust multisensor for compressed air achieved
- Reliable measurement of pressure, flow & temperature
- Assembly as an "electrofluidic SMD" demonstrated

Outlook

- Reduce required power for flow measurement
- **Mixed fluidic / electronic boards**